INTEGRATED CIRCUITS

DATA SHEET

74F5218-bit identity comparator

Product specification

1990 May 15

IC15 Data Handbook





74F521

FEATURES

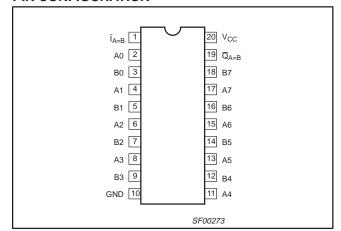
- Compares two 8-bit words in 6.5ns typical
- Expandable to any word length

DESCRIPTION

The 74F521 is an expandable 8-bit comparator. It compares two words of up to 8 bits each and provides a Low output when the two words match bit for bit. The expansion input $\overline{\rm I}_{A=B}$ also serves as an active-Low enable input.

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F521	7.0ns	24mA

PIN CONFIGURATION



ORDERING INFORMATION

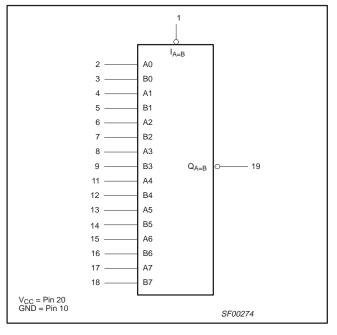
DESCRIPTION	COMMERCIAL RANGE V_{CC} = 5V $\pm 10\%$, T_{amb} = 0°C to +70°C	PKG DWG #
20-pin plastic DIP	N74F521N	SOT146-1
20-pin plastic SOL	N74F521D	SOT163-1

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

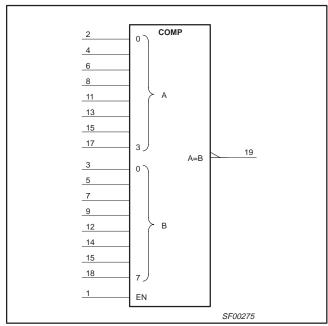
PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
A0 – A7	Word A inputs	1.0/1.0	20μA/0.6mA
B0 – B7	Word B inputs	1.0/1.0	20μA/0.6mA
Ī _{A=B}	Expansion or Enable input (active Low)	1.0/1.0	20μA/0.6mA
$\overline{Q}_{A=B}$	Identity output (active Low)	50/33	1.0mA/20mA

NOTE: One (1.0) FAST unit load is defined as: 20µA in the High state and 0.6mA in the Low state.

LOGIC SYMBOL



IEC/IEEE SYMBOL

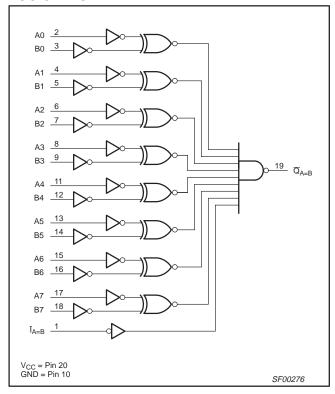


Philips Semiconductors Product specification

8-bit identity comparator

74F521

LOGIC DIAGRAM



FUNCTION TABLE

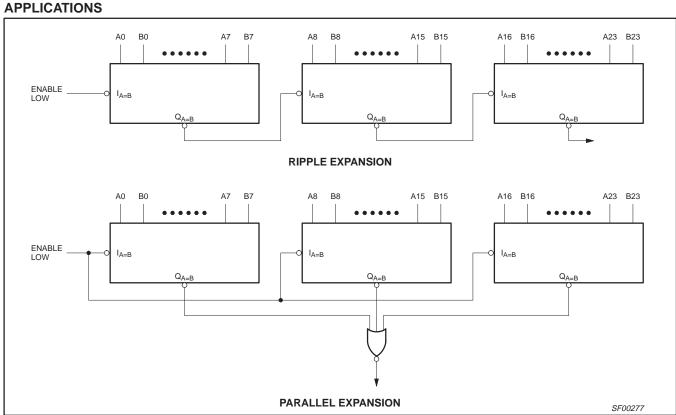
INP	JTS	OUTPUT				
Ī _{A=B}	A, B	$\overline{Q}_{A=B}$				
L	A=B*	L				
L	A≠B	Н				
н	A=B*	Н				
Н	A≠B	Н				

H = High voltage level

L = Low voltage level

X = Don't care

* A0=B0, A1=B1, A2=B2, etc.



Philips Semiconductors Product specification

8-bit identity comparator

74F521

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V _{CC}	Supply voltage	-0.5 to +7.0	V
V _{IN}	Input voltage	−0.5 to +7.0	V
I _{IN}	Input current	−30 to +5	mA
V _{OUT}	Voltage applied to output in High output state	−0.5 to V _{CC}	V
I _{OUT}	Current applied to output in Low output state	40	mA
T _{amb}	Operating free-air temperature range	0 to +70	°C
T _{stg}	Storage temperature range	-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		LIMITS		UNIT
STWIBUL	PARAMETER	MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage	4.5	5.0	5.5	V
V _{IH}	High-level input voltage	2.0			V
V _{IL}	Low-level input voltage			0.8	V
I _{IK}	Input clamp current			-18	mA
I _{OH}	High-level output current			-1	mA
I _{OL}	Low-level output current			20	mA
T _{amb}	Operating free-air temperature range	0		+70	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER		TEST CONDITION	nue1		LIMITS		UNIT	
STWIBOL	FARAMETER		TEST CONDITIO	MIN	TYP ²	MAX	OMIT		
V	Lligh lovel output voltoge		$V_{CC} = MIN, V_{IL} = MAX$	$V_{IL} = MAX \pm 10\% V_{CC}$ 2.5				V	
V _{OH}	High-level output voltage		V _{IH} = MIN, I _{OH} = MAX	±5%V _{CC}	2.7	3.4		V	
\ <u></u>	Low lovel output voltage		$V_{CC} = MIN, V_{IL} = MAX$	±10%V _{CC}		0.30	0.50	٧	
V _{OL}	Low-level output voltage		V _{IH} = MIN, I _{OL} = MAX	±5%V _{CC}		0.30	0.50	V	
V _{IK}	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$		-0.73	-1.2	V		
I _I	Input current at maximum input v	oltage	$V_{CC} = MAX, V_I = 7.0V$			100	μΑ		
I _{IH}	High-level input current		$V_{CC} = MAX, V_I = 2.7V$			20	μΑ		
I _{IL}	Low-level input current		$V_{CC} = MAX, V_I = 0.5V$				-0.6	mA	
I _{OS}	Short-circuit output current ³		V _{CC} = MAX	-60		-150	mA		
	Overally source of (total)		V - MAY	·		24	36	mA	
lcc	Supply current (total)	I _{CCL}	V _{CC} = MAX			24	36	mA	

NOTES:

- For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
 All typical values are at V_{CC} = 5V, T_{amb} = 25°C.
 Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

May 15, 1990

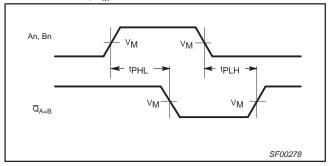
74F521

AC ELECTRICAL CHARACTERISTICS

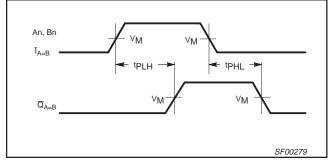
				LIMITS						
SYMBOL	PARAMETER	TEST CONDITION	Tai	_{CC} = +5.0 _{mb} = +25 0pF, R _L =	°C	V _{CC} = +5. T _{amb} = 0°C C _L = 50pF,	UNIT			
			MIN	TYP	MAX	MIN	MAX			
t _{PLH} t _{PHL}	Propagation delay An or Bn to $\overline{\mathbf{Q}}_{\mathbf{A}=\mathbf{B}}$	Waveform 1, 2	3.5 3.0	8.0 8.0	9.5 9.0	3.5 2.5	11.0 10.5	ns		
t _{PLH} t _{PHL}	Propagation delay $\overline{I}_{A=B}$ to $\overline{Q}_{A=B}$	Waveform 2	3.0 3.5	5.0 6.5	6.5 7.0	3.0 3.5	7.5 8.0	ns		

AC WAVEFORMS

For all waveforms, $V_M = 1.5V$.

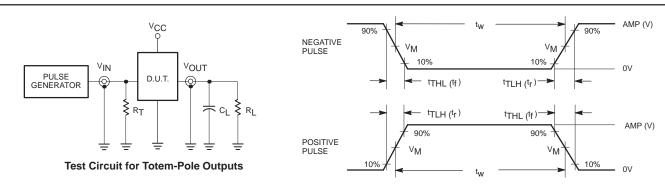


Waveform 1. For Inverting Outputs



Waveform 2. For Non-Inverting Outputs

TEST CIRCUIT AND WAVEFORMS



family

74F

5

DEFINITIONS:

R_L = Load resistor;

see AC ELECTRICAL CHARACTERISTICS for value. Load capacitance includes jig and probe capacitance; see AC ELECTRICAL CHARACTERISTICS for value.

Termination resistance should be equal to Z_{OUT} of pulse generators.

INPUT PULSE REQUIREMENTS											
amplitude	V _M	rep. rate	t _w	t _{TLH}	t _{THL}						
3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns						

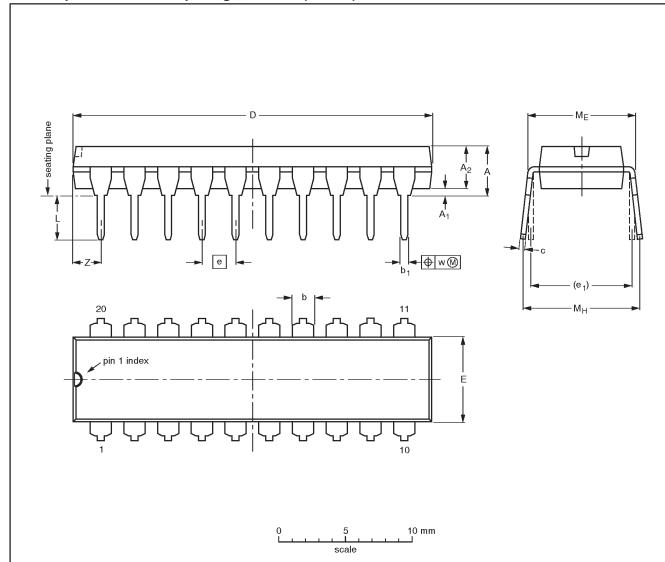
Input Pulse Definition

SF00006

74F521

DIP20: plastic dual in-line package; 20 leads (300 mil)

SOT146-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	0.36 0.23	26.92 26.54	6.40 6.22	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.0
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.014 0.009	1.060 1.045	0.25 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.078

Note

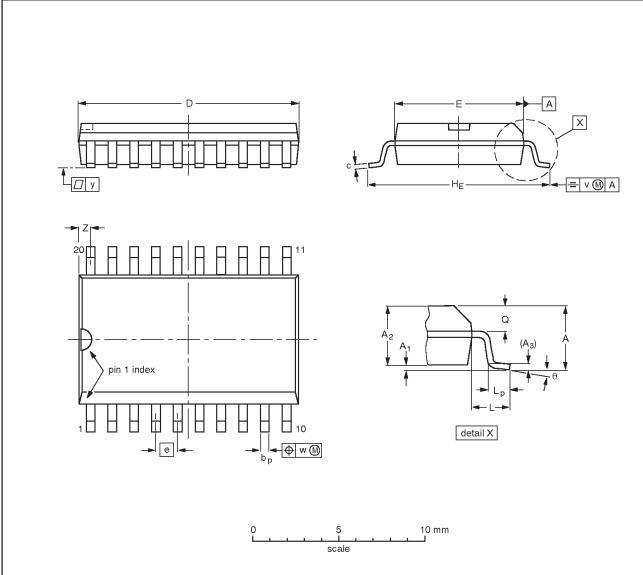
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT146-1			SC603			92-11-17 95-05-24

6

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	Ьp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	z ⁽¹⁾	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFEF	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013AC			-95-01-24 97-05-22

74F521

Data sheet status

Data sheet status	Product status	Definition [1]	
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.	
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later d Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.	
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible pro	

^[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Disclaimers

Life support — These products are not designed for use in life support appliances, devices or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

Philips Semiconductors 811 East Arques Avenue P.O. Box 3409 Sunnyvale, California 94088–3409 Telephone 800-234-7381 © Copyright Philips Electronics North America Corporation 1998 All rights reserved. Printed in U.S.A.

print code Date of release: 10-98

Document order number: 9397-750-05129

Let's make things better.

Philips Semiconductors



